



SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	114.285000 MHz
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL
SPEC. NO. (P/N)	FLB420001
CUSTOMER P/N	
ISSUE DATE	August 23, 2019
VERSION	

APPROVED	APPROVED PREPARED	
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- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

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VERSION HISTORY

Version No.	Version Date	Description	Notes
А	Oct.26,2007	Initial Release	
В	May.14,2009	Revised Format	
С	Nov.26,2009	Changed Mode of Oscillation from to Fundamental to 3rd OT	
D	Aug.25,2010	New Logo	
E	Feb.16,2011	Updated Suggested IR Reflow Profile & Format	
F	Aug.25,2016	1.Changed ESR to 58Ω max. 2.Changed Shunt Capacitance to 2pF max. 3.Updated mechanical drawings	
G	Dec.13,2017	Updated Logo	
Н	Aug.23,2019	Corrected Mode of Oscillation from to Fundamental to 3rd OT	



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ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	114.285000	MHz	
Mode of Oscillation	МО	AT Cut - 3rd OT		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	±100	ppm	at 25℃±3℃
Operating Temperature Range	TR	-40 to +85	C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±100	ppm	Reference to the Frequency at 25℃
Operating Drive Level		100	μW	
Equivalent Series Resistance	ESR	58	Ω	Max
Shunt Capacitance	C0	2	pF	Max
Aging at 25℃		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	C	
Insulation Resistance		500	МΩ	Min

★ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



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RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

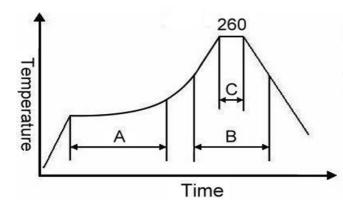
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



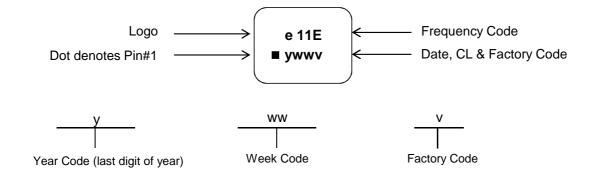
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	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

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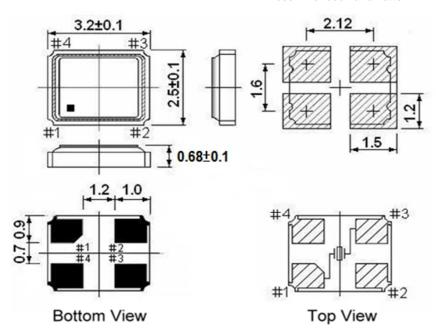
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

Notes:

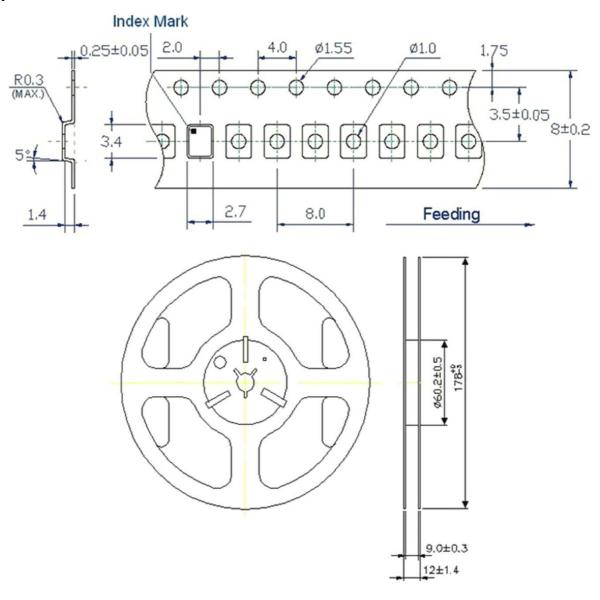
- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.



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Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

